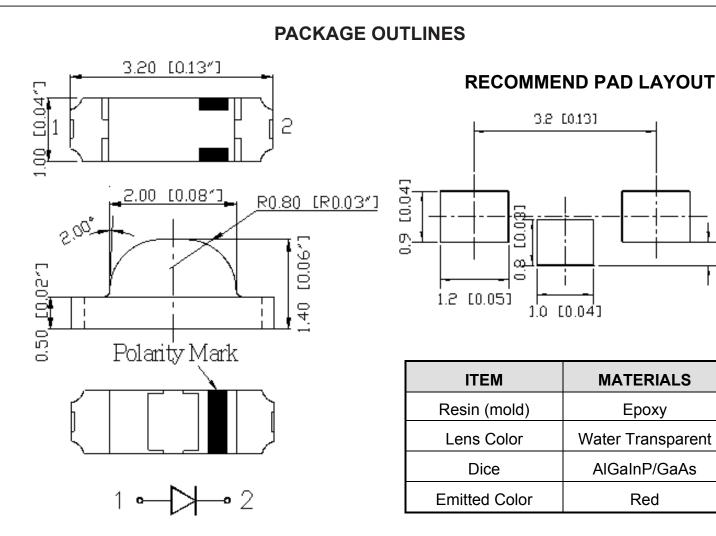


#### CSR124R2C **SPECIFICATION**



ITEM	MATERIALS			
Resin (mold)	Ероху			
Lens Color	Water Transparent			
Dice	AlGaInP/GaAs			
Emitted Color	Red			

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSR124R2C	InGaAlP	Red	Water Clear	150°	





## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μΑ	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+80	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lfP	125	mA	
Soldering Temperature	TsoL	Max 260°C for	5 sec Max	

# **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

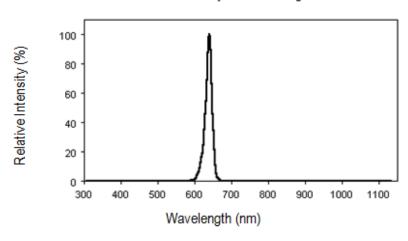
Parameter	Symbol	Test Condition	Value			Lloit
			Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	50	85	-	mcd
Forward Voltage	VF	IF = 20mA	-	2.0	2.5	V
Reverse Leakage Current	lr	V <sub>R</sub> = 5V	-	-	10	μΑ
Viewing Angle at 50% Iv	201/2	IF = 20mA	1	150	1	Deg
Peak Wavelength	λp	IF = 20mA	-	640	-	nm
Dominant Wavelength	<b>λ</b> D	IF = 20mA	-	630	-	nm

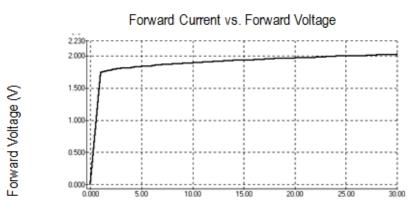
<sup>\*</sup>Tolerance of viewing angle: -10 / +5 deg.



# **OPTICAL CHARACTERISTIC CURVES**

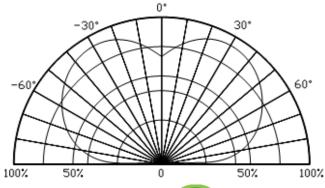
### Relative Intensity vs. Wavelength





Forward Current (mA)

#### Directive Characteristics

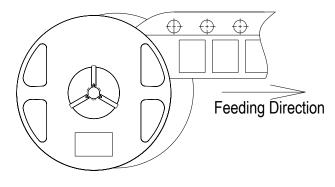


RoHS Compliant

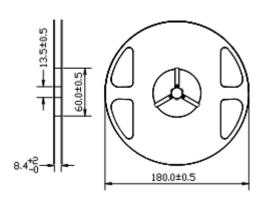


## **PACKAGING SPECIFICATION**

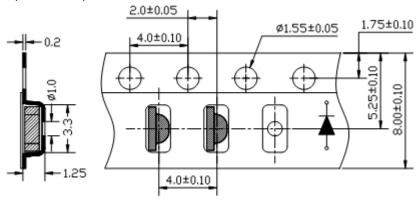
### **Feeding Direction**



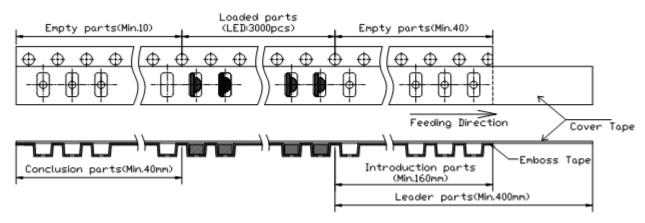
## Dimensions of Reel (Unit: mm)



### Dimensions of Tape (Unit: mm)



#### Arrangement of Tape



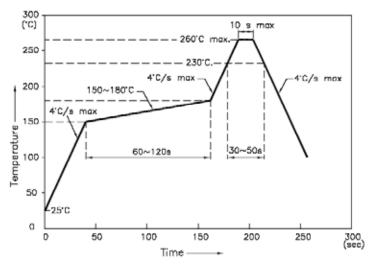
- Empty component pockets are sealed with top cover tape
- The maximum number of missing lamps is two
- The cathode is oriented towards the tape sprocket hole
- 3,000 pcs/Reel





## **SOLDERING CONDITIONS**

#### **REFLOW PROFILE**



- 1. We recommend the reflow temperature 245°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Do not cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process should be 2 times or less.

#### Soldering Iron

Basic spec is ≤5sec when 260°C. If temperature is higher, time should be shorter (+10°C→-1sec). Power dissipation of iron should be smaller than 20W and temperature should be controllable. Surface temperature of the device should be under 230°C.

#### Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron cannot touch copper foil.
- 3. Twin-head type is preferred.

